

## BF545A; BF545B; BF545C

# N-channel silicon junction field-effect transistors Rev. 03 — 5 August 2004 Product da

**Product data sheet** 



#### 1.1 General description

N-channel symmetrical silicon junction field-effect transistors in a SOT23 package.

#### **CAUTION**



This device is sensitive to electrostatic discharge (ESD). Therefore care should be taken during transport and handling.

#### 1.2 Features

- Low leakage level (typ. 500 fA)
- High gain
- Low cut-off voltage (max. 2.2 V for BF545A).

#### 1.3 Applications

- Impedance converters in e.g. electret microphones and infra-red detectors
- VHF amplifiers in oscillators and mixers.

#### 1.4 Quick reference data

Table 1: Quick reference data

| Symbol           | Parameter                   | Conditions                                    | Min  | Тур | Max  | Unit |
|------------------|-----------------------------|-----------------------------------------------|------|-----|------|------|
| $V_{DS}$         | drain-source voltage        |                                               | -    | -   | ±30  | V    |
| $V_{GSoff}$      | gate-source cut-off voltage | $I_D = 1 \mu A; V_{DS} = 15 V$                | -0.4 | -   | -7.8 | V    |
| I <sub>DSS</sub> | drain current               | $V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$ |      |     |      |      |
|                  |                             | BF545A                                        | 2    | -   | 6.5  | mA   |
|                  |                             | BF545B                                        | 6    | -   | 15   | mA   |
|                  |                             | BF545C                                        | 12   | -   | 25   | mA   |
| P <sub>tot</sub> | total power dissipation     | T <sub>amb</sub> ≤ 25 °C                      | -    | -   | 250  | mW   |
| y <sub>fs</sub>  | forward transfer admittance | $V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$ | 3    | -   | 6.5  | mS   |





Table 2: Pinning

|     | 3           |                    |            |
|-----|-------------|--------------------|------------|
| Pin | Description | Simplified outline | Symbol     |
| 1   | source (s)  |                    |            |
| 2   | drain (d)   | 3                  | g → d<br>s |
| 3   | gate (g)    | 1 2<br>SOT23       | g →        |

## 3. Ordering information

**Table 3: Ordering information** 

|             | 5       |                                          |         |  |  |  |
|-------------|---------|------------------------------------------|---------|--|--|--|
| Type number | Package |                                          |         |  |  |  |
|             | Name    | Description                              | Version |  |  |  |
| BF545A      | -       | plastic surface mounted package; 3 leads | SOT23   |  |  |  |
| BF545B      |         |                                          |         |  |  |  |
| BF545C      |         |                                          |         |  |  |  |

## 4. Marking

Table 4: Marking

| Type number | Marking code [1] |
|-------------|------------------|
| BF545A      | 20*              |
| BF545B      | 21*              |
| BF545C      | 22*              |

<sup>[1] \* =</sup> p: made in Hong Kong.

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<sup>\* =</sup> t: made in Malaysia.

<sup>\* =</sup> W: made in China.



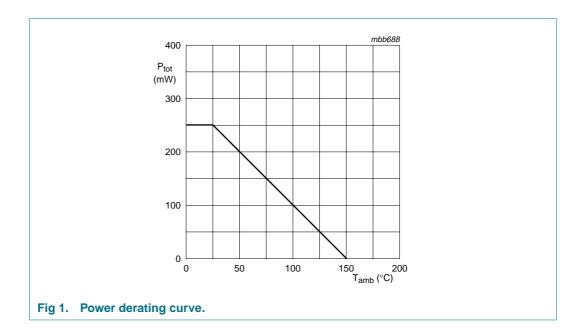
## 5. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter                 | Conditions               | Min          | Max  | Unit |
|------------------|---------------------------|--------------------------|--------------|------|------|
| $V_{DS}$         | drain-source voltage (DC) |                          | -            | ±30  | V    |
| $V_{GSO}$        | gate-source voltage       | open drain               | -            | -30  | V    |
| $V_{GDO}$        | gate-drain voltage (DC)   | open source              | -            | -30  | V    |
| I <sub>G</sub>   | forward gate current (DC) |                          | -            | 10   | mA   |
| P <sub>tot</sub> | total power dissipation   | T <sub>amb</sub> ≤ 25 °C | <u>[1]</u> _ | 250  | mW   |
| T <sub>stg</sub> | storage temperature       |                          | -65          | +150 | °C   |
| Tj               | junction temperature      |                          | -            | 150  | °C   |

[1] Device mounted on an FR4 printed-circuit board, maximum lead length 4 mm; mounting pad for the drain lead 10 mm<sup>2</sup>.



### 6. Thermal characteristics

Table 6: Thermal characteristics

| Symbol        | Parameter                                   | Conditions |            | Тур | Unit |
|---------------|---------------------------------------------|------------|------------|-----|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient |            | <u>[1]</u> | 500 | K/W  |

<sup>[1]</sup> Device mounted on an FR4 printed-circuit board, maximum lead length 4 mm; mounting pad for the drain lead 10 mm<sup>2</sup>.



## 7. Static characteristics

**Table 7: Static characteristics** 

 $T_i = 25 \,^{\circ}C$  unless otherwise specified.

| Symbol           | Parameter                       | Conditions                                                                      | Min  | Тур  | Max   | Unit |
|------------------|---------------------------------|---------------------------------------------------------------------------------|------|------|-------|------|
| $V_{(BR)GSS}$    | gate-source breakdown voltage   | $I_G = -1 \mu A; V_{DS} = 0 V$                                                  | -30  | -    | -     | V    |
| $V_{GSoff}$      | gate-source cut-off voltage     | $I_D = 200 \mu A; V_{DS} = 15 V$                                                |      |      |       |      |
|                  |                                 | BF545A                                                                          | -0.4 | -    | -2.2  | V    |
|                  |                                 | BF545B                                                                          | -1.6 | -    | -3.8  | V    |
|                  |                                 | BF545C                                                                          | -3.2 | -    | -7.8  | V    |
|                  |                                 | $I_D = 1 \mu A; V_{DS} = 15 V$                                                  | -0.4 | -    | -7.5  | V    |
| I <sub>DSS</sub> | drain current                   | $V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$                                   |      |      |       |      |
|                  |                                 | BF545A                                                                          | 2    | -    | 6.5   | mA   |
|                  |                                 | BF545B                                                                          | 6    | -    | 15    | mA   |
|                  |                                 | BF545C                                                                          | 12   | -    | 25    | mA   |
| I <sub>GSS</sub> | gate-source leakage current     | $V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V}$                                  | -    | -0.5 | -1000 | pА   |
|                  |                                 | $V_{GS} = -20 \text{ V}; V_{DS} = 0 \text{ V};$<br>$T_j = 125 ^{\circ}\text{C}$ | -    | -    | -100  | nA   |
| y <sub>fs</sub>  | forward transfer admittance     | $V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$                                   | 3    | -    | 6.5   | mS   |
| y <sub>os</sub>  | common source output admittance | $V_{GS} = 0 \text{ V}; V_{DS} = 15 \text{ V}$                                   | -    | 40   | -     | μS   |

## 8. Dynamic characteristics

Table 8: Dynamic characteristics

 $T_{amb} = 25 \,^{\circ}C$  unless otherwise specified.

| Symbol           | Parameter                    | Conditions                                    | Min | Тур | Max | Unit |
|------------------|------------------------------|-----------------------------------------------|-----|-----|-----|------|
| C <sub>iss</sub> | input capacitance            | $V_{DS} = 15 \text{ V; } f = 1 \text{ MHz}$   |     |     |     |      |
|                  |                              | V <sub>GS</sub> = −10 V                       | -   | 1.7 | -   | pF   |
|                  |                              | V <sub>GS</sub> = 0 V                         | -   | 3   | -   | pF   |
| C <sub>rss</sub> | reverse transfer capacitance | V <sub>DS</sub> = 15 V; f = 1 MHz             |     |     |     |      |
|                  |                              | V <sub>GS</sub> = −10 V                       | -   | 0.8 | -   | pF   |
|                  |                              | V <sub>GS</sub> = 0 V                         | -   | 0.9 | -   | pF   |
| gis              | common source input          | $V_{DS} = 10 \text{ V}; I_D = 1 \text{ mA}$   |     |     |     |      |
|                  | conductance                  | f = 100 MHz                                   | -   | 15  | -   | μS   |
|                  |                              | f = 450 MHz                                   | -   | 300 | -   | μS   |
| <b>g</b> fs      | common source transfer       | $V_{DS} = 10 \text{ V}; I_D = 1 \text{ mA}$   |     |     |     |      |
|                  | conductance                  | f = 100 MHz                                   | -   | 2   | -   | mS   |
|                  |                              | f = 450 MHz                                   | -   | 1.8 | -   | mS   |
| g <sub>rs</sub>  | common source reverse        | $V_{DS} = 10 \text{ V}; I_D = 1 \text{ mA}$   |     |     |     |      |
|                  | conductance                  | f = 100 MHz                                   | -   | -6  | -   | μS   |
|                  |                              | f = 450 MHz                                   | -   | -40 | -   | μS   |
| gos              | common source output         | $V_{DS} = 10 \text{ V}; I_{D} = 1 \text{ mA}$ |     |     |     |      |
|                  | conductance                  | f = 100 MHz                                   | -   | 30  | -   | μS   |
|                  |                              | f = 450 MHz                                   | -   | 60  | -   | μS   |

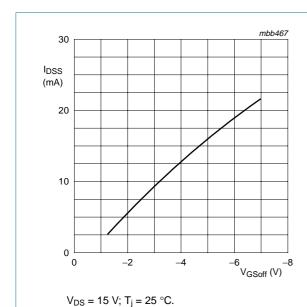
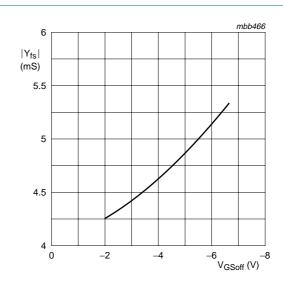


Fig 2. Drain current as a function of gate-source cut-off voltage; typical values.



 $V_{DS}$  = 15 V;  $V_{GS}$  = 0 V;  $T_j$  = 25 °C.

Fig 3. Forward transfer admittance as a function of gate-source cut-off voltage; typical values.

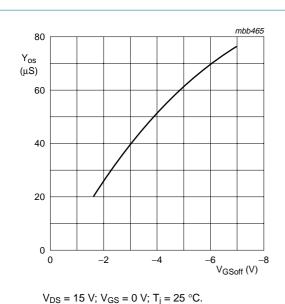
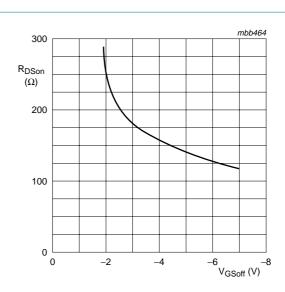
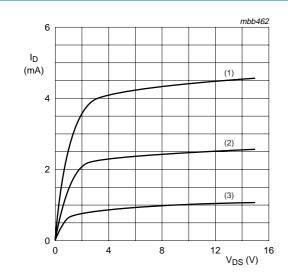


Fig 4. Common-source output admittance as a function of gate-source cut-off voltage; typical values.



 $V_{DS}$  = 100 mV;  $V_{GS}$  = 0 V;  $T_j$  = 25 °C.

Fig 5. Drain-source on-resistance as a function of gate-source cut-off voltage; typical values.

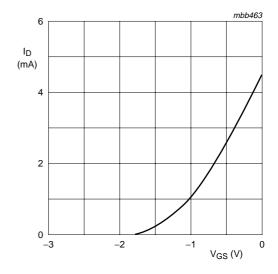


#### BF545A

$$T_i = 25 \, ^{\circ}C$$
.

- (1)  $V_{GS} = 0 \text{ V}.$
- (2)  $V_{GS} = -0.5 \text{ V}.$
- (3)  $V_{GS} = -1.0 \text{ V}.$

Fig 6. Typical output characteristics.

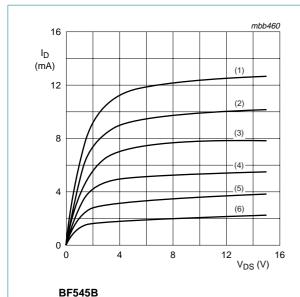


#### BF545A

 $V_{DS} = 15 \text{ V}; T_i = 25 ^{\circ}\text{C}.$ 

Fig 7. Typical input characteristics.





## $T_i = 25 \,^{\circ}\text{C}.$

(1) 
$$V_{GS} = 0 \text{ V}.$$

(2) 
$$V_{GS} = -0.5 \text{ V}.$$

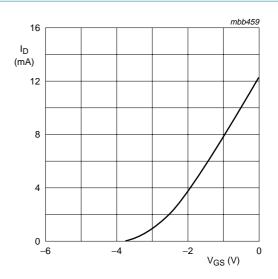
(3) 
$$V_{GS} = -1.0 \text{ V}.$$

(4) 
$$V_{GS} = -1.5 \text{ V}.$$

(5) 
$$V_{GS} = -2.0 \text{ V}.$$

(6)  $V_{GS} = -2.5 \text{ V}.$ 

Fig 8. Typical output characteristics.

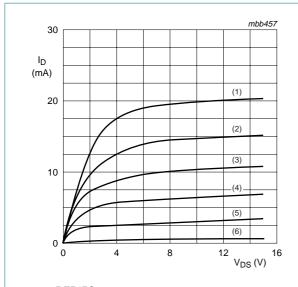


#### BF545B

 $V_{DS} = 15 \text{ V}; T_i = 25 \,^{\circ}\text{C}.$ 

Fig 9. Typical input characteristics.





#### BF545C

$$T_j = 25 \, ^{\circ}C.$$

(1) 
$$V_{GS} = 0 V$$
.

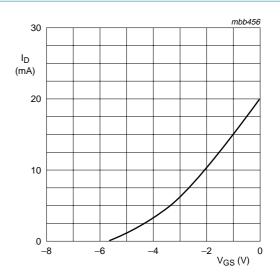
(2) 
$$V_{GS} = -1.0 \text{ V}.$$

(3) 
$$V_{GS} = -2.0 \text{ V}.$$

(4) 
$$V_{GS} = -3.0 \text{ V}.$$
  
(5)  $V_{GS} = -4.0 \text{ V}.$ 

(6) 
$$V_{GS} = -5.0 \text{ V}.$$

Fig 10. Typical output characteristics.



#### BF545C

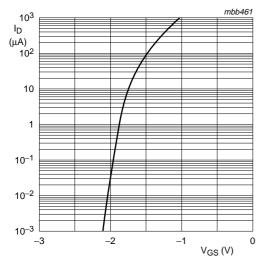
$$V_{DS} = 15 \text{ V}; T_i = 25 \,^{\circ}\text{C}.$$

Fig 11. Typical input characteristics.

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mbb458

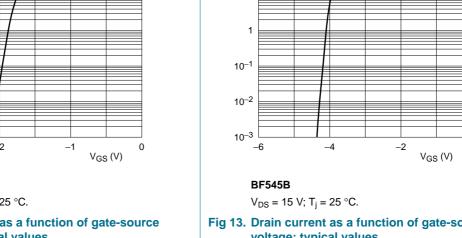
0



BF545A

 $V_{DS} = 15 \text{ V}; T_i = 25 ^{\circ}\text{C}.$ 

Fig 12. Drain current as a function of gate-source voltage; typical values.



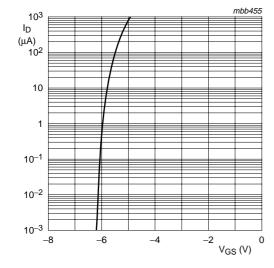
10<sup>3</sup>  $I_{\mathsf{D}}$ 

102

10

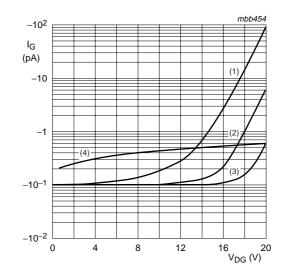
(μA)

Fig 13. Drain current as a function of gate-source voltage; typical values.



 $V_{DS} = 15 \text{ V}; T_i = 25 ^{\circ}\text{C}.$ 

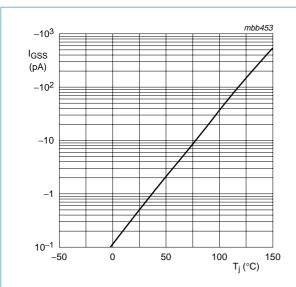
Fig 14. Drain current as a function of gate-source voltage; typical values.



 $I_D = 10$  mA only for BF545B and BF545C;  $T_i = 25$  °C.

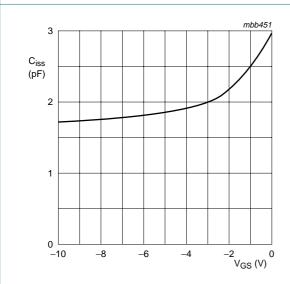
- (1)  $I_D = 10 \text{ mA}$ .
- (2)  $I_D = 1 \text{ mA}$ .
- (3)  $I_D = 0.1 \text{ mA}.$
- (4) I<sub>GSS</sub>.

Fig 15. Gate current as a function of drain-gate voltage; typical values.



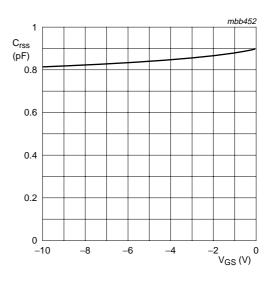
 $V_{DS} = 0 \text{ V}; V_{GS} = -20 \text{ V}.$ 

Fig 16. Gate current as a function of junction temperature; typical values.



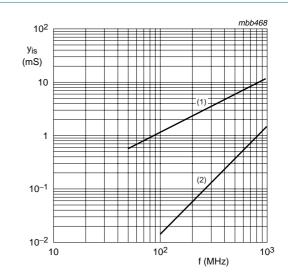
 $V_{DS} = 15 \text{ V}; T_i = 25 ^{\circ}\text{C}.$ 

Fig 18. Typical input capacitance.



 $V_{DS} = 15 \text{ V}; T_i = 25 ^{\circ}\text{C}.$ 

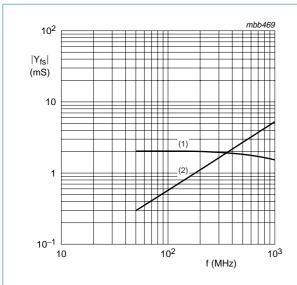
Fig 17. Reverse transfer capacitance as a function of gate-source voltage; typical values.



 $V_{DS} = 10 \text{ V}; I_{D} = 1 \text{ mA}; T_{amb} = 25 \,^{\circ}\text{C}.$ 

- (1) b<sub>is</sub>.
- (2) g<sub>is</sub>.

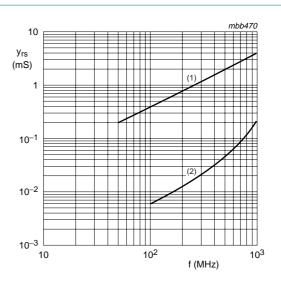
Fig 19. Common-source input admittance; typical values.



$$V_{DS}$$
 = 10 V;  $I_D$  = 1 mA;  $T_{amb}$  = 25 °C.

- (1)  $g_{fs}$
- (2)  $-b_{fs}$ .

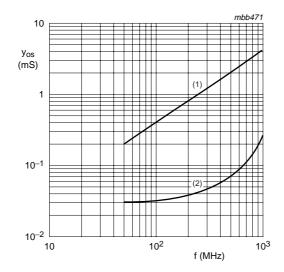
Fig 20. Common-source forward transfer admittance; typical values.



$$V_{DS} = 10 \text{ V}; I_D = 1 \text{ mA}; T_{amb} = 25 ^{\circ}\text{C}.$$

- -b<sub>rs</sub>
- (2) -g<sub>rs</sub>.

Fig 21. Common-source reverse transfer admittance; typical values.



$$V_{DS} = 10 \text{ V}; I_D = 1 \text{ mA}; T_{amb} = 25 ^{\circ}\text{C}.$$

- (1) b<sub>os</sub>.
- (2)  $g_{os}$

Fig 22. Common-source output admittance; typical values.

## 9. Package outline

#### Plastic surface mounted package; 3 leads

SOT23

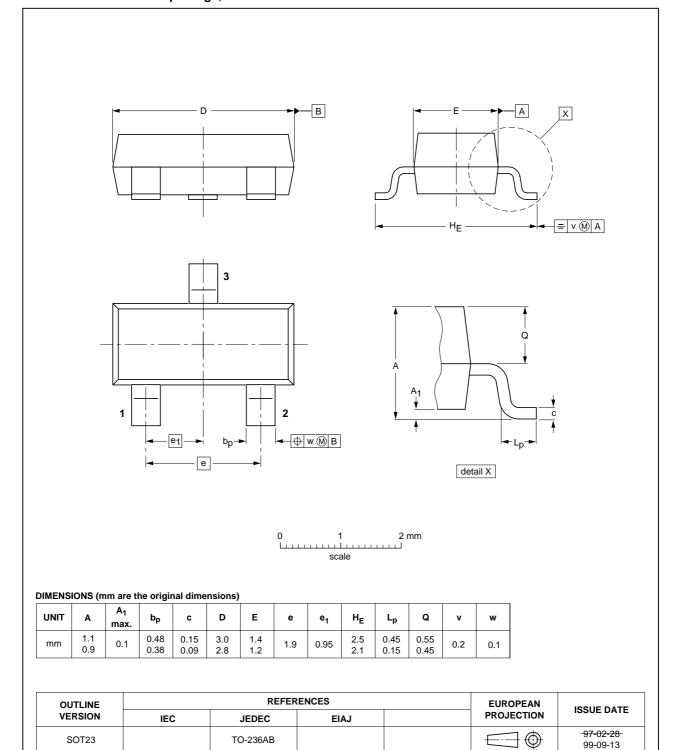


Fig 23. Package outline.



## 10. Revision history

#### Table 9: Revision history

| Document ID                | Release date | Data sheet status                                                                    | Change notice | Order number        | Supersedes       |
|----------------------------|--------------|--------------------------------------------------------------------------------------|---------------|---------------------|------------------|
| BF545A_BF545B_<br>BF545C_3 | 20040805     | Product data sheet                                                                   | -             | 9397 750 13391      | BF545A-B-C_2     |
| Modifications:             | information  | of this data sheet has be<br>standard of Philips Ser<br>de changed, see <u>Table</u> | niconductors  | comply with the new | presentation and |
| BF545A-B-C_2               | 19960729     | Product specification                                                                | -             | -                   | -                |

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## BF545A; BF545B; BF545C

N-channel silicon junction field-effect transistors



| Level | Data sheet status [1] | Product status [2] [3] | Definition                                                                                                                                                                                                                                                                                     |
|-------|-----------------------|------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| I     | Objective data        | Development            | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.                                                                                                    |
| II    | Preliminary data      | Qualification          | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.             |
| III   | Product data          | Production             | This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). |

- [1] Please consult the most recently issued data sheet before initiating or completing a design.
- [2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- [3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

#### 12. Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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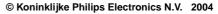
## **Philips Semiconductors**

## BF545A; BF545B; BF545C

N-channel silicon junction field-effect transistors

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Date of release: 5 August 2004 Document order number: 9397 750 13391

